October 14, 2024

Marvell to Showcase Accelerated Infrastructure for AI at 2024 OCP Global Summit

Data Center Portfolio Powers the Next Generation of AI and Cloud

SANTA CLARA, Calif., Oct. 14, 2024 /PRNewswire/ -- **2024 OCP Global Summit –** Marvell Technology, Inc. (NASDAQ: MRVL), a leader in data infrastructure semiconductor solutions, will highlight its latest advancements in accelerated infrastructure at the 2024 OCP Global Summit, October 15-17, in San Jose, California. During this premier industry event uniting thought leaders in the open IT ecosystem, Marvell will demonstrate how its accelerated infrastructure portfolio enables the next generation of AI and cloud data centers.

At the 2024 OCP Global Summit, Marvell will showcase next-generation silicon technologies, including PAM4 DSPs, PCIe retimers, Ethernet network switches, and Compute Express Link® (CXL) devices. These innovations are designed to meet the scaling requirements of AI-driven workloads, optimize cloud network performance, and address the evolving needs of data centers globally.

Join Marvell at the 2024 OCP Global Summit in San Jose

Visit booth B1 to discover how the Marvell accelerated infrastructure portfolio is driving the future of AI and cloud networks. Products and solutions include:

- Alaska® 1.6T PAM4 DSPs for AECs
- Alaska PCIe Gen 6 retimers and Gen 7 SerDes
- COLORZ® 800 ZR/ZR+ modules for data center interconnect
- Nova and Spica PAM4 DSPs for AI and cloud connectivity
- Orion coherent DSP for DCI modules
- Teralynx® Ethernet switches for cloud and AI networking

Marvell experts will lead several discussions and sessions focused on scaling accelerated infrastructure:

- **Keynote Panel: Scaling Interconnect and Memory for AI Clusters**
  Date: Tuesday, October 15, 2024
  Time: 9:36 a.m.
  Location: Concourse Level - Grand Ballroom 220
  Marvell panelist: Nigel Alvares, Vice President, Global Marketing

- **Marvell® Structera™: Overcoming Computing's Memory Challenges with Optimized CXL Devices**
  Date: Tuesday, October 15, 2024

Time: 2:40 p.m.
Location: Lower Level – LL 20A
Marvell presenter: Khurram Malik, Director, Product Marketing

- **Expo Hall Session: DSPs in AI and Cloud Connectivity**
  Date: Tuesday, October 15, 2024
  Time: 4:25 p.m.
  Location: Concourse Level – Expo Hall Stage
  Marvell presenter: Venu Balasubramonian, Vice President of Product Marketing, Connectivity Business Unit

- **Executive Session: Open Network Switching for Hyperscale Cloud AI Infrastructure**
  Date: Tuesday, October 15, 2024
  Time: 4:40 p.m.
  Location: Concourse Level – 210DH
  Marvell presenter: Nick Kucharewski, Senior Vice President and General Manager of the Network Switching Business Unit

- **AI/HPC Future Fabrics Panel**
  Date: Wednesday, October 16, 2024
  Time: 9:40 a.m.
  Location: Lower Level – LL20BC
  Marvell panelist: Jack Harwood, Senior Distinguished Engineer

- **Panel: What is the Right Path Forward for the Industry?**
  Date: Wednesday, October 16, 2024
  Time: 11:00 a.m.
  Location: Concourse Level – 220C
  Marvell panelist: Dr. Loi Nguyen, Executive Vice President and General Manager, Cloud Optics

- **Workshop: Leverage the Full Ecosystem to Enable AI**
  Date: Wednesday, October 16, 2024
  Time: 12:30 p.m.
  Location: Lower Level – LL20D
  Marvell presenter: Jack Harwood, Senior Distinguished Engineer

- **Panel: Open Compute Components Executive Panel: Delivering AI Systems at Scale in A Multi-Vendor Environment**
  Date: Thursday, October 17, 2024
  Time: 8:20 a.m.
  Location: Concourse Level – 220C
  Marvell panelist: Dr. Loi Nguyen, Executive Vice President and General Manager, Cloud Optics

- **Memory wall mitigation and acceleration of AI workloads, and in-memory databases using CXL Near Memory Compute accelerator**
  Date: Thursday, October 17, 2024
  Time: 12:30 p.m.
  Location: Concourse Level – 210BF
  Marvell presenter: Gaurav Agarwal, Sr. Director Engineering

About Marvell
To deliver the data infrastructure technology that connects the world, we're building solutions on the most powerful foundation: our partnerships with our customers. Trusted by the world's leading technology companies for over 25 years, we move, store, process and secure the world's data with semiconductor solutions designed for our customers' current needs and future ambitions. Through a process of deep collaboration and transparency, we're ultimately changing the way tomorrow's enterprise, cloud, automotive, and carrier architectures transform—for the better.

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